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Ana Bengoechea-Encabo, Steven Albert, D. Lopez-Romero, Pierre Lefebvre, Francesca Barbagini, et al.. Light-Emitting-Diodes based on ordered InGaN nanocolumns emitting in the blue, green and yellow spectral range.. *Nanotechnology*, 2014, 25 (43), pp.435203. 10.1088/0957-4484/25/43/435203 . hal-01073992

HAL Id: hal-01073992

<https://hal.science/hal-01073992v1>

Submitted on 14 May 2024

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Light-Emitting-Diodes based on ordered InGaN nanocolumns emitting in the blue, green and yellow spectral range

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Abstract

The growth of ordered arrays of InGaN/GaN nanocolumnar light emitting diodes by molecular beam epitaxy, emitting in the blue (441 nm), green (502 nm), and yellow (568 nm) spectral range is reported. The device active region, consisting of a nanocolumnar InGaN section of nominally constant composition and 250 to 500 nm length, is free of extended defects, which is in strong contrast to InGaN (planar) layers of similar composition and thickness. Electroluminescence spectra show a very small blue shift with increasing current (almost negligible in the yellow device) and line widths slightly broader than those of state-of-the-art InGaN quantum wells.

Keywords: InGaN, nanocolumns, LED, SAG

1. Introduction

The potential of InGaN alloys to generate light emission in the UV to IR range makes them an ideal choice for light emitting diodes (LED) covering the whole visible range and beyond. Typically, LEDs are based on multi quantum well (MQW) structures reaching their maximum external quantum efficiency (EQE) at relatively low current injection, below 10 A cm^{-2} . At higher injection currents, the so-called efficiency ‘droop’ is observed even under pulsed current conditions, where self-heating effects are avoided. Several mechanisms such as carrier overflow and Auger recombination have been suggested as possible reasons to explain the droop effect [1–3]. Auger recombination is proportional to the third power of the carrier density (n^3), indicating that its impact would be drastically reduced by increasing the active region volume of the device (lower carrier density). This approach has been proposed and pursued by some groups using a double-heterostructure InGaN active layer, thicker

than a typical QW, but still in the range of 10 to 20 nm [4, 5]. In these cases, an increase in the EQE has been observed, with a peak value shifting to higher currents. However, this approach would only be of real use if the thicker InGaN layers have good enough quality, i.e. no dislocations, which can be partly achieved by using free-standing GaN templates [5]. Indeed, it has been shown that the use of these low-defect substrates to grow LEDs with standard InGaN MQW active regions shifts the maximum EQE position to higher currents [6]. On the other hand, since the inefficient confinement of electrons in the InGaN active region is one of the reasons for the current overflow, a thicker region could also contribute to reduce this phenomenon, although other approaches, such as the use of electron blocking layers [3, 7], are more widespread.

As an alternative to planar devices, proposals of LEDs based on arrays of self-assembled nanocolumns (NCs) with embedded InGaN quantum disks (QDisk) or dots (QDs) have been reported in past years [8–12]. The advantages of NC-based LEDs are twofold: i) higher light extraction efficiency (without need of complicated technological processes)

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exploiting the guiding properties inherent to these ‘cylindrical’ nanostructures [13], and ii) active layers with very high crystalline quality and reduced strain. However, self-assembled NCs have critical drawbacks, such as an intrinsic polychromaticity and a strong geometrical and electrical dispersion that greatly complicate processing and hamper efficiency [8, 14].

In order to address these issues, selective area growth (SAG) of III-nitride NCs by molecular beam epitaxy (MBE) has been developed in recent years, achieving highly homogeneous and controllable arrays of InGa_N/Ga_N nanocolumnar heterostructures with either embedded InGa_N QDisks [15] or long InGa_N portions [16, 17]. Recently, LEDs based on ordered arrays of NCs with embedded MQW emitting in the green [18] and red [19] as well as with an InGa_N section of 80 nm thickness emitting in the near infrared range [20] have been demonstrated.

In contrast, this work reports on the growth, processing and characterization of blue, green and yellow LEDs (p-i-n structures) based on ordered NCs with much longer InGa_N active regions (between 250 nm and 500 nm). The results obtained point to this specific geometry as a potential alternative to the use of embedded InGa_N QDisks, as well as to standard planar geometries using QWs, for its application for LEDs. In addition, the fact that thick InGa_N sections (above 250 nm) embedded on p-i-n ordered NCs can be grown without traces of extended defects, as reported in this work, which is in contrast to the typical results for planar structures, makes this design very appealing for solar cells as well [21, 22].

2. Experimental details

All samples were grown by SAG on commercial GaN(0001)/sapphire templates in a RIBER Compact 21 PA-MBE system. The impinging molecular fluxes were calibrated in (0001) Ga_N (for Ga and N) and (0001) In_N (for In) growth rate units (nm/min) [23]. Prior to the growth, the templates were covered by a thin Ti mask with a compact hexagonal lattice of nanoholes made by colloidal lithography. Details of this procedure can be found elsewhere [24]. The nanohole lattice had a period (P, distance between centers of closest holes) of 280 nm, and diameter around 150 nm. Determined by the mask design the NCs density was $\sim 1.15/P^2 \sim 1.5E9 \text{ cm}^{-2}$. The initial filling factor, defined as the ratio between the NCs footprint and the wafer area, was 0.26. However, during the growth of the InGa_N/Ga_N:Mg nanocolumnar sections the NC diameter increased due to the effects of In and Mg on the radial growth rate [25, 26], as it can be seen in figures 1(b) and (c), causing the filling factor to increase up to 0.72.

Two samples (A1, A2) of NCs with stacked Ga_N:Mg/InGa_N/Ga_N:Si sections (p-i-n structures) were grown following a three-step process: (i) 2 h 30 min growth of Ga_N:Si NCs at 860 °C (Ga-flux, $\Phi_{\text{Ga}} = 16 \text{ nm min}^{-1}$ and N-flux, $\Phi_{\text{N}} = 5 \text{ nm min}^{-1}$) with a Si cell temperature of 950 °C; (ii) growth of an InGa_N section at 650 °C ($\Phi_{\text{Ga}} = 2.3 \text{ nm min}^{-1}$, $\Phi_{\text{In}} = 6.4 \text{ nm min}^{-1}$, and $\Phi_{\text{N}} = 12 \text{ nm min}^{-1}$) during 1 h in

sample A1 and 30 min in sample A2 (thicknesses of 500 nm and 250 nm respectively); and (iii) 30 min growth of Ga_N:Mg at 600 °C ($\Phi_{\text{Ga}} = 10 \text{ nm min}^{-1}$ and $\Phi_{\text{N}} = 7 \text{ nm min}^{-1}$) with a Mg cell temperature of 365 °C. Although the same growth conditions were used for the InGa_N growth in both samples, LEDs emitting from blue up to yellow could be fabricated. This was caused by a temperature gradient of around 20 °C along the wafer during the MBE growth (highest temperature at the edge of the wafer), leading to a varying In incorporation from the wafer center (higher In%) to the edge (lower In%).

Three different devices were processed from these samples: i) D1 emitting in the blue from sample A1; ii) D2 emitting in the green, and iii) D3 emitting in yellow, both originating from sample A2. According to the wavelengths, the estimated In contents [27] are 18.6%, 27% and 33.7% for D1, D2 and D3, respectively. The devices have a circular shape (defined by the mesa etching) of 100 μm diameter. The n-type contact was a conventional Ti/Al/Ti/Au (20/200/40/55 nm) electrode deposited by electron beam evaporation on the Ga_N template. On top of the NCs, a Ni/Au (20/500 nm) p-type electrode was deposited by thermal evaporation, using 500 nm of Au to ensure proper current spreading. Thermal evaporation was carried out under an incidence angle of around 30° and sample rotation. The small distance between NCs (maximum filling factor of 0.72) facilitates the metallization of the top contact by direct evaporation, without using filling material between NCs. The annealing conditions for both ohmic contacts were 5 min at 450 °C under H₂:N₂ atmosphere. The light was collected through the sapphire substrate, which leads to a strong light intensity reduction to 1 or 2% of its original value due to the Ga_N/sapphire and sapphire/air interfaces [19].

The nanostructures and devices were characterized by scanning electron microscopy (SEM), transmission electron microscopy (TEM) and scanning transmission electron microscopy (STEM). High resolution TEM and atomic resolution characterization was performed on a JEOL JEM-ARM200cF electron microscope (cold emission gun) operating at 200 kV provided with a spherical aberration corrector in probe (current density $\sim 1.4 \times 10^{-9} \text{ A}$ and probe size $\sim 0.08 \text{ nm}$). Solid semi-angles between 11–22 mrad were used for the acquisition of annular bright field (ABF) images [28] using an acquisition time of 38 s per frame. In addition the nanostructures were characterized using I–V measurements, and room temperature (RT) pulsed electroluminescence (EL) with a 1% duty cycle and 1 μs pulses.

3. Results and discussion

The low magnification image of a representative NC projected onto the (010) plane is displayed in figure 1(c). NCs have a wurtzite-type crystal structure which is directly observed in the atomically resolved ABF-STEM image shown in figure 1(d), revealing the disposition of the Ga and N atomic columns. No structural defects are detected in the Ga_N:Si/InGa_N sections (zone A in figure 1(c)), but at the NCs’ top (zone B in figure 1(c)) the formation of twin

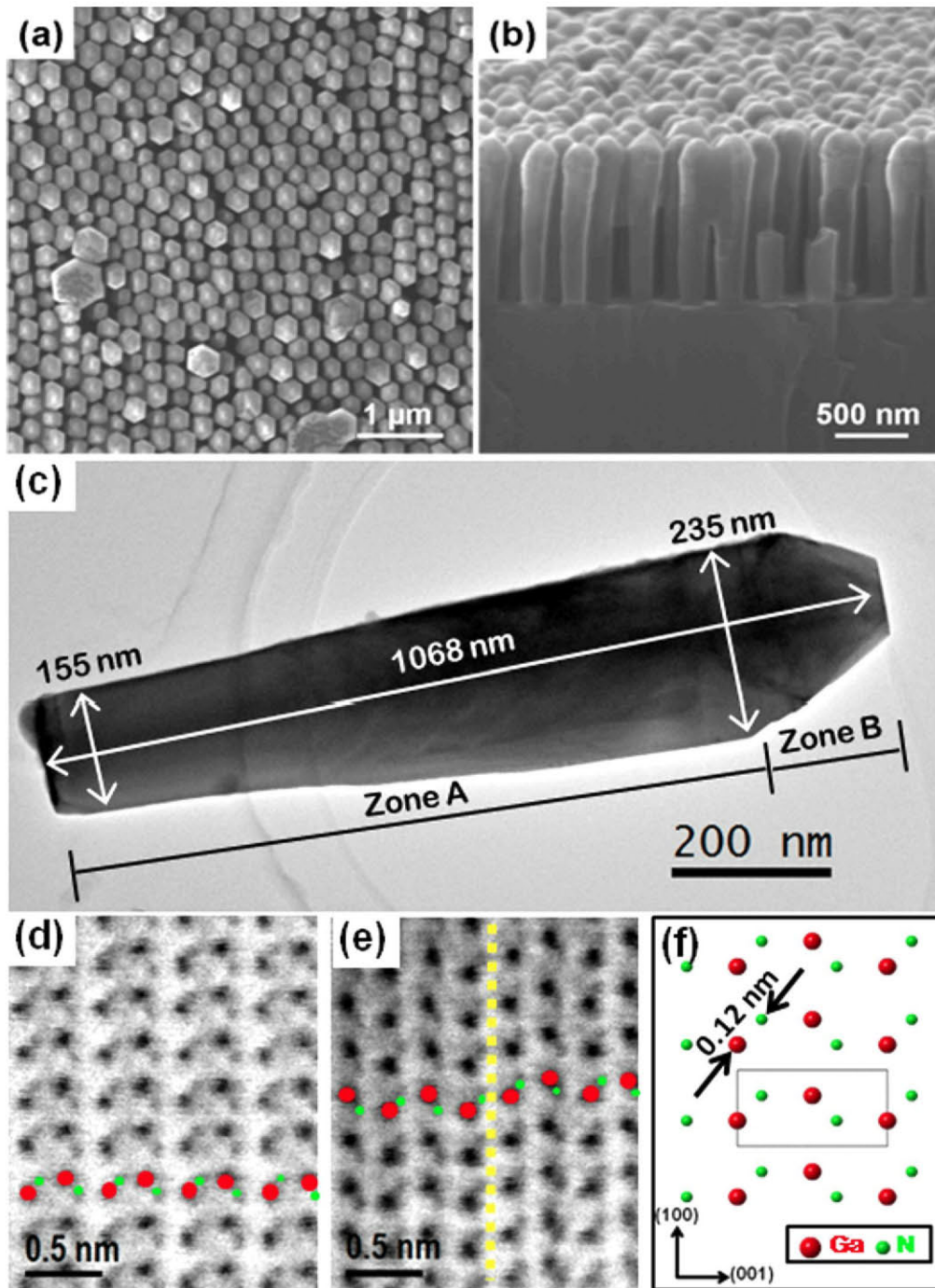


Figure 1. SEM pictures of sample A1: (a) top view, and (b) bird's-eye view; (c) low magnification TEM image of a single NC of sample A1; atomically-resolved ABF-STEM images of (d) GaN:Si/InGaN (zone A); and (e) GaN:Mg (zone B) highlighted sections (sample A1). (f) Schematic representation of Ga- and N-atoms position in wurtzite structure.

boundaries create one monolayer of a blende-type structure (dashed line in figure 1(e)). The appearance of these extended structural defects is most likely caused by the low temperature growth of the upper p-type GaN section. As no consecutive twins are observed, the formation of an extended blende-type structure at the NCs' top can be ruled out.

Although the current-voltage (I - V) characteristics of the devices show a non-negligible leakage current, a rectifying behaviour with a reasonable turn-on voltage is found,

as shown in figure 2(b). Since no filling material was used to isolate/passivate the NCs, the top ohmic contact could partially short-circuit the p- and n-sides, provoking the observed leakage. Remarkably, no clear dependence between emission wavelength and turn-on voltage was found. The reason for this is unclear at this point, and is currently under investigation. A possibility may relate to the In distribution inside the NCs, e.g. in device D1, emitting in the blue range, regions of higher In-content exist that

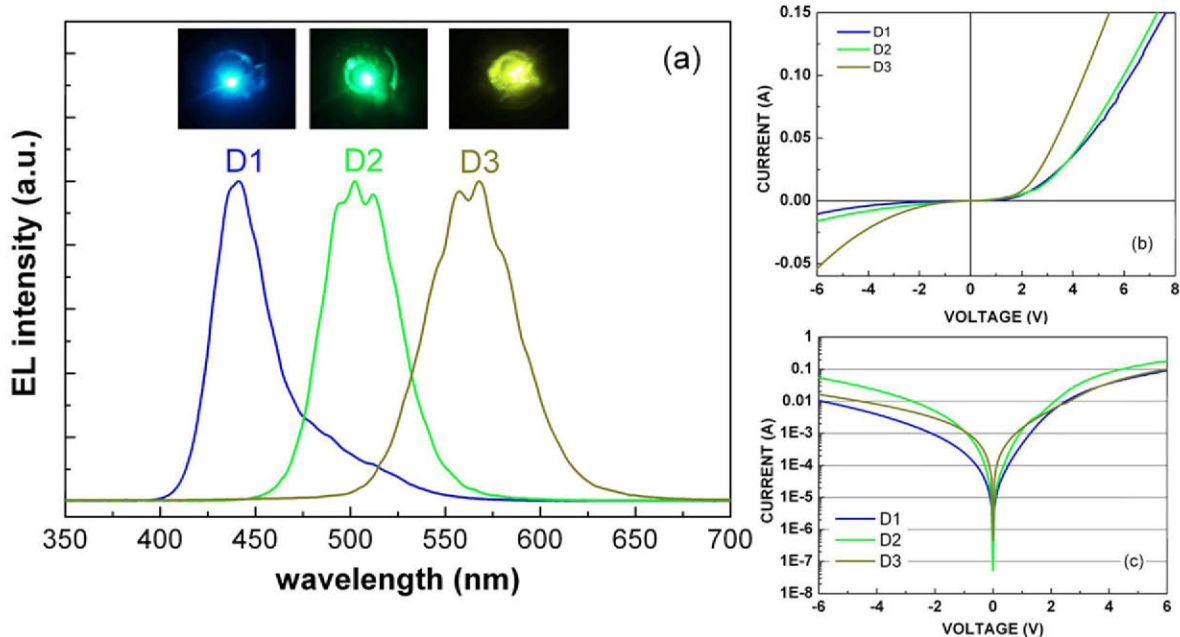


Figure 2. (a) Normalized RT-EL spectra of the three devices, at the maximum injected current (150 mA, nominal). The inset shows photographs of the light emission during the EL measurements. (b) I-V characteristic of the devices, and (c) the same I-V characteristics on semi-log plot.

dominate emission at lower injection currents, as will be discussed later on.

RT-EL measurements were performed from 10 mA (127 A cm^{-2} , considering the area of the circular device) to 150 mA (1910 A cm^{-2}) in pulsed mode to avoid self heating effects, with a 1% duty cycle and pulses of $1 \mu\text{s}$. Taking into account the observed leakage currents for the three different devices, the actual injected currents can be estimated to be around 1700 A cm^{-2} , 1439 A cm^{-2} and 1600 A cm^{-2} for devices D1, D2 and D3, respectively. In addition it has to be noted that based on the calculation in reference [29], unpassivated NCs of the given diameter of 230 nm (figure 1(c)) would have an injection efficiency of only about 10%. With that in mind the effectively injected current densities would be 170 A cm^{-2} , 144 A cm^{-2} and 160 A cm^{-2} , which is still far beyond the normal operation range of commercial LEDs. On the other hand, since the NCs do not cover the whole circular device area (filling factor < 1), the actual current densities would be higher than the ones calculated considering the device circular area. Normalized RT-EL spectra at the maximum injected current (150 mA nominal) are shown in figure 2(a) for the three devices. At this maximum injected current, EL spectra peak at 441 nm (D1), 502 nm (D2) and 568 nm (D3). In the case of the blue device (D1), a pronounced tail clearly extends into longer wavelengths. This issue will be discussed later.

Assuming that extraction efficiency is not dependent on excitation, the EQE can be considered proportional to the ratio between the integrated EL intensity (L) and the current density (J). No absolute values of EQE can be provided due to setup limitations.

Figure 3 shows the L/J ratio as a function of the (nominal) current density (as explained before, the actual value for

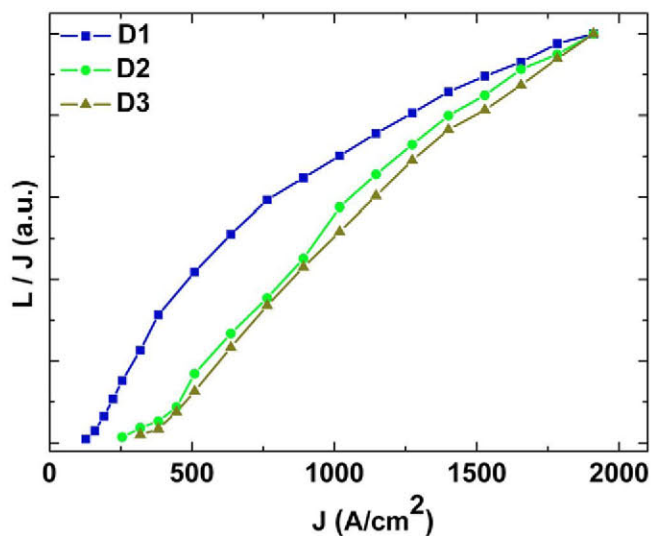


Figure 3. L/J versus J dependence for devices D1, D2 and D3.

the maximum current density differs from the nominal value) for the three devices, where no evidence of efficiency droop is observed. In standard planar LEDs, EQE reaches its maximum value at current densities around 10 A cm^{-2} or smaller, with efficiency droop at higher injection densities. Only in some approaches, most of them involving low-defective substrates, it is possible to shift the maximum EQE value to higher currents [4–6]. On the other hand, in the case of devices based on self-assembled NCs, high current densities are reached with virtually no efficiency droop, as in reference [12], with current densities up to 2200 A cm^{-2} .

According to the ABC model [1] the EQE can be modeled taking into account three parameters: i) the

Shockley–Read–Hall (SRH) coefficient, named A, related to nonradiative recombination at crystal defects; ii) the radiative coefficient, named B; and iii) the nonradiative Auger coefficient, named C. Following this model, the maximum efficiency is reached when the carrier density (n) equals $(A/C)^{0.5}$. The highly increased active volume of the devices presented here compared to standard ones based on QWs, leads to a lower carrier density for a given injection current density. Thus the EQE is expected to peak at higher current densities than in standard QW based devices. Figure 3 may indicate that the EL experiments were carried out at low enough carrier density so that the EQE peak is not reached. On the other hand it has to be noted that usually the fact that the EQE peak is not reached at high injection may also indicate a high defect related nonradiative recombination, although in the present case, it would be surprising given the absence of extended defects, as shown in figure 1 (point defects may still be present). However, considering the slow rise of L/I values with increasing injection, and that the NCs are not passivated, a strong nonradiative surface recombination at the InGaN sidewalls may take place, which would lead to a reduction of the injection efficiency and thus of the internal quantum efficiency as shown in self-assembled nanocolumnar LEDs [29]. In that respect, no conclusive point can be made in terms of the absence of the droop effect.

The evolution of the EL peak wavelength with current density for the three devices is presented in figure 4(a), and the corresponding shifts ($\Delta\lambda$) are indicated for devices D1 and D2. Device D3 (yellow) shows no wavelength shift, while device D2 (green) shows a blue-shift of 14 nm within the current density range between 254 A cm^{-2} and 891 A cm^{-2} , followed by an almost constant value up to the maximum injected current. A similar behavior is found for device D1 (blue), which shows the largest blue shift (around 18 nm between 159 A cm^{-2} and 509 A cm^{-2}) among all three devices.

Figure 4(b) shows a general trend of line width reduction with current injection in all three devices, more pronounced for D1 (until a stable value is reached beyond 1000 A cm^{-2}), followed by D3, and finally an almost negligible effect for D2. At the highest injection current (150 mA) the measured EL line widths are of 35 nm, 45 nm and 55 nm for the blue (441 nm), green (502 nm) and yellow (568 nm) devices (figure 4(c)). A similar trend has been reported for planar QW based LEDs [30, 31], namely, 20 nm, 35 nm and 50 nm for blue, green and orange LEDs, and was explained in terms of increasing alloy disorder for higher In contents. The higher line width values measured in D1 to D3 LEDs can be attributed to: (i) slight variations of NCs diameters due to a less than perfectly regular colloidal mask and, consequently, of In content [15], thus broadening the EL spectrum (the effects on NC diameter by mask geometry dispersion can be seen in figure 1(a)); and (ii) In% distribution within the InGaN section on each NC due to lattice pulling and In(GaN) thermal decomposition [32, 33]. Remarkably, the EL spectral line widths of devices D1 to D3 are narrower than those reported for LEDs using ordered NCs with InGaN QDisc

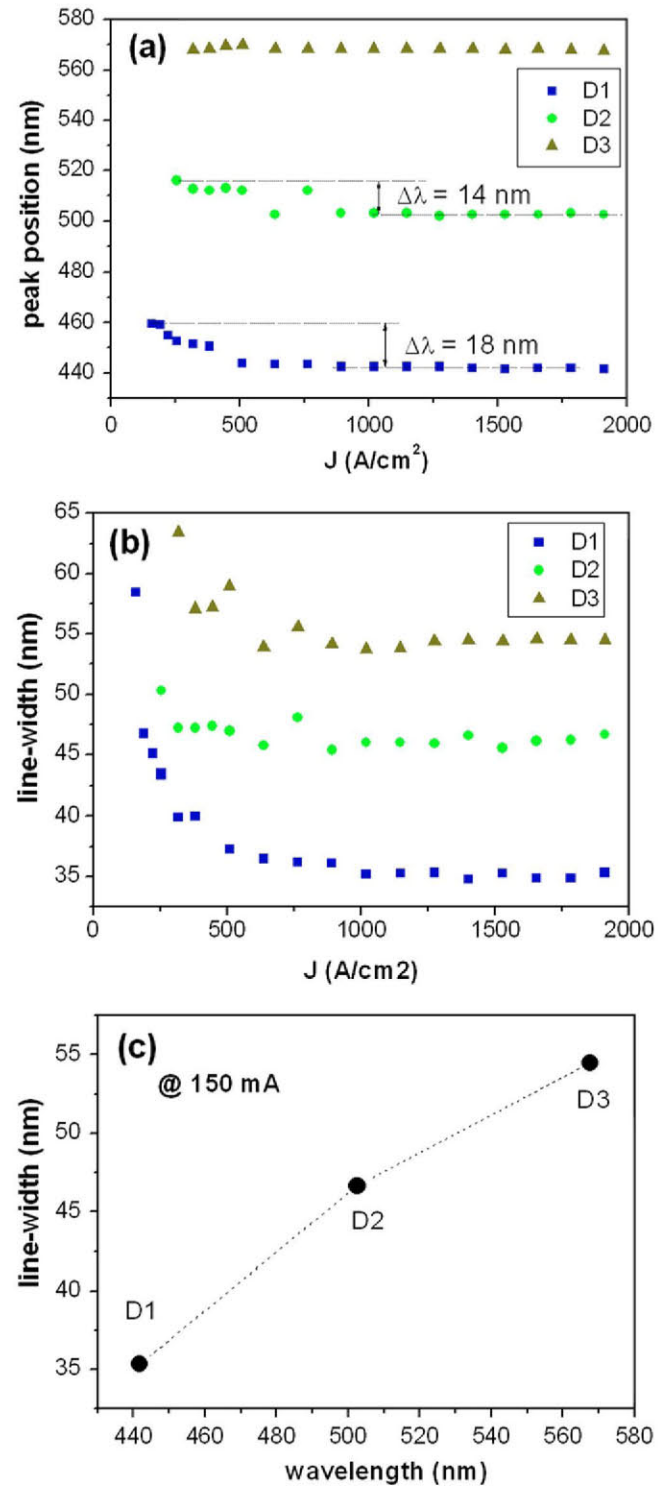


Figure 4. (a) EL peak wavelength dependence on current density indicating the peak shifts for devices D1 and D2; (b) EL spectra line width evolution with current density for devices D1, D2 and D3; and (c) EL spectra line widths for the three devices, at the maximum injected current (150 mA).

active regions (67 nm, 96 nm, 54 nm at a peak wavelengths of 544 nm, 583 nm and 597 nm respectively) [18].

The typical blue shift and line width narrowing observed in InGaN QWs and QDs upon increasing excitation has generally been explained by screening of the internal electric

field [34, 35]. The same trend is found in the devices analyzed in this work (figures 4(a) and (b)) though in this case the most reasonable explanation relies on the presence of localized states within the InGaN sections. In the present work, it can be speculated that different distributions and depths of localized states may be present in the three devices D1, D2 and D3. In device D1 (blue LED) a low-density distribution of localized states is assumed to be present close to the conduction band (CB) bottom, whereas a distribution of localized states with higher density and depth, but much wider spread in energy as to merge into the CB, may be present in devices D2 and D3 due to a higher In-content. In addition, it has to be taken into account that the residual n-type carrier density increases with increasing In% [36] leading to different positions of the Fermi level with respect to the CB edge in the three devices. Having in mind both the differences in localization and Fermi level position, the energy blue shift and the reduction of FWHM with increasing injection current can partially be understood.

In the blue LED (device D1) the Fermi level position is assumed to be slightly above the localized states. At low injection current, emission from localized states is assumed to dominate (low energy peak). With increasing injection current, the Fermi level would shift into the CB and consequently the EL emission would be dominated by the CB states (high energy peak). Due to the much higher density of states (DOS) in the CB, an overall reduction of the line width with increasing injection current would be observed. This interpretation is backed up by the data from the EL spectrum in figure 5(a), where two resolved EL peaks with similar intensity are observed at low current injection; one at higher energy (emission from the CB) and a second one at lower energy (emission from localized states). When increasing the current injection, the higher energy peak becomes dominant (much higher CB DOS) with a concomitant narrowing of the emission peak. At this point it has to be noted that no significant shift of the Fermi level is assumed to take place once the CB is reached. This assumption is reasonable when taking into account the efficient recombination of carriers as well as the high effective masses (flat band) in nitrides.

In the green (D2) and yellow (D3) devices (EL spectra shown in figures 5(b) and (c)) the EL peak width at low injection current is assumed to reflect the energy spread of all the localized states (merging into the CB), which all add to the emission due to the Fermi level position well above them (which is due to the higher In content). An increase of the injection current would start ‘filling up’ the localized states (which have a much higher DOS compared to devices D1), as well as CB states, once all localized states are filled, which would again cause a blue shift as well as reduction of the line width as in the case of the blue device, although much less severe due to the higher DOS of the localized states in devices D2 and D3.

However, it cannot be ruled out that the blue shift, as well as line-width reduction, is also related to different filling states of the localized states inside the InGaN volume. Since the center of the InGaN volume can be assumed to have a higher In content than the verges [37], at a low injection

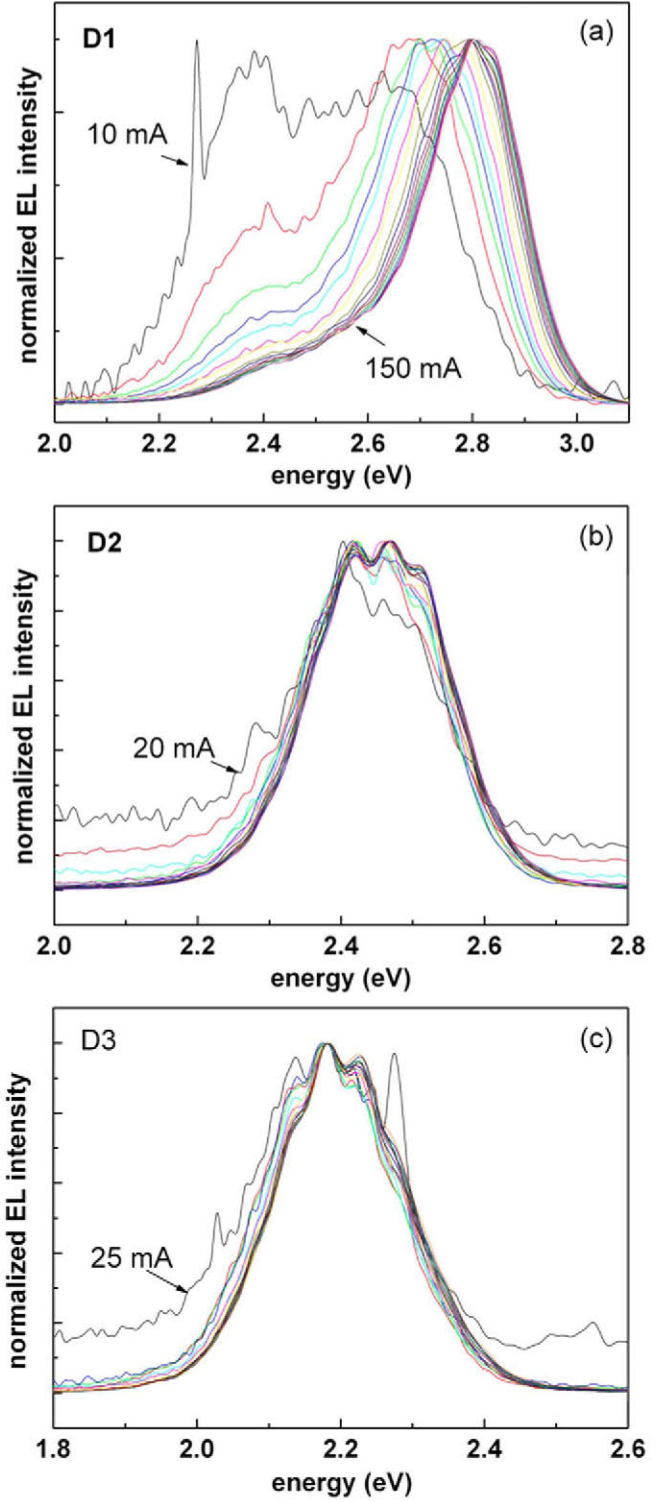


Figure 5. (a) EL spectra of device D1, from low injected current (10 mA) to high injected current (150 mA). At low injection, emission is formed by two peaks of similar intensities, while at high injection, the low energy peak is attenuated. (b) and (c) are the EL spectra for devices D2 and D3, respectively.

current it is reasonable to assume that the carriers tend to fill the localized states towards the center of the InGaN volume, while on the verges of the central zone the filling will be lesser. Due to this inhomogeneous saturation degree, the

emission would be rather broad. Upon increasing injection current, the central (saturated) recombination region tends to spread along the entire InGaN volume and eventually saturation of localized states extends over the entire InGaN volume, thus reducing the line width. This effect would be more pronounced for devices D2 and D3 due to the higher length of the InGaN segment.

4. Conclusion

In summary, blue (441 nm), green (502 nm) and yellow (568 nm) LEDs, based on ordered NCs having long InGaN active regions (250 nm to 500 nm), were successfully achieved. The long InGaN segments were found to be defect-free and the only twin boundaries were found in the upper GaN:Mg region, most likely due to the low temperature used for the growth of this region. Pulsed EL measurement up to (nominally) 1900 A cm^{-2} did not show droop or saturation of the efficiency, while the emission wavelength experiences only a small blue shift, almost negligible for the yellow device (568 nm). In addition, a narrowing of the emission line widths was found. Finally, the line width values measured are slightly higher than those reported for planar MQW structures, but in the range of, or better than, the values reported for ordered nanoLEDs using InGaN QDiscs. These nanoLEDs with embedded thick InGaN regions may have potential in lighting applications, since they combine the ordered NCs advantages (high homogeneity, quality, light extraction efficiency, etc) with the benefits of a thick InGaN active region (reduction of Auger recombination and current overflow mechanism) without crystal quality degradation.

Acknowledgments

We acknowledge partial financial support by the EU FP7 Contract GECCO 280694, the EU ITN RAINBOW PITN-GA-2008-213238, and Ministerio de Ciencia e Innovación: MAT2011-26703.

References

- [1] Piprek J 2010 *Phys. Status Solidi A* **207** 2217–25
- [2] Kioupakis E, Rinke P, Delaney K T and Van de Walle C 2011 *Appl. Phys. Lett.* **98** 161107
- [3] Vampola K J, Iza M, Keller S, DenBaars S P and Nakamura S 2009 *Appl. Phys. Lett.* **94** 061116
- [4] Gardner N F, Müller G O, Shen Y C, Chen G, Watanabe S, Götz W and Krames M R 2007 *Appl. Phys. Lett.* **91** 243506
- [5] Maier M, Köhler K, Kunzer M, Pletschen W and Wagner J 2009 *Appl. Phys. Lett.* **94** 041103
- [6] Liu Z, Wei T, Guo E, Yi X, Wang L, Wang J, Wang G, Shi Y, Ferguson I and Li J 2011 *Appl. Phys. Lett.* **99** 091104
- [7] Wang C H *et al* 2010 *Appl. Phys. Lett.* **97** 261103
- [8] Kikuchi A, Kawai M, Tada M and Kishino K 2004 *Jpn. J. of Appl. Phys.* **43** L1524
- [9] Kim H-M, Cho Y-H, Lee H, Kim S I, Ryu S R, Kim D Y, Kang T W and Chung K S 2004 *Nano Lett.* **4** 1059
- [10] Guo W, Zhang M, Banerjee A and Bhattacharya P 2010 *Nano Lett.* **10** 3355
- [11] Nguyen H P T, Zhang S, Cui K, Han X, Fatholouloumi S, Couillard M, Botton G A and Mi Z 2011 *Nano Lett.* **11** 1919
- [12] Nguyen H P T, Cui K, Zhang S, Djavid M, Korinek A, Botton G A and Mi Z 2012 *Nano Lett.* **12** 1317
- [13] Henneghien A-L, Tourbot G, Daudin B, Lartigue O, Désières Y and Gérard J-M 2011 *Optics Express* **19** 527
- [14] Bavencove A L, Tourbot G, Garcia J, Désières Y, Gilet P, Levy F, Andre B, Gayral B, Daudin B and Dang L S 2011 *Nanotechnology* **22** 345705
- [15] Sekiguchi H, Kishino K and Kikuchi A 2010 *Appl. Phys. Lett.* **96** 231104
- [16] Albert S, Bengoechea-Encabo A, Kong X, Sanchez-Garcia M A, Calleja E and Trampert A 2013 *Appl. Phys. Lett.* **102** 181103
- [17] Albert S, Bengoechea-Encabo A, Sanchez-Garcia M A, Kong X, Trampert A and Calleja E 2013 *Nanotechnology* **24** 175303
- [18] Kishino K, Nagashima K and Yamano K 2013 *Appl. Phys. Express* **6** 012101
- [19] Vadivelu R, Igawa Y and Kishino K 2013 *Jpn. J. Appl. Phys.* **52** 08JE18
- [20] Kishino K, Kamimura J and Kamiyama K 2012 *Appl. Phys. Express* **5** 031001
- [21] Feng S-W, Lai C-M, Chen C-H, Sun W-C and Tu L-W 2010 *J. Appl. Phys.* **108** 093118
- [22] Golam S A T M and Myers R C 2012 *Appl. Phys. Lett.* **101** 143905
- [23] Heying B, Averbek R, Chen L F, Haus E, Riechert H and Speck J S 2000 *J. Appl. Phys.* **88** 1855
- [24] Bengoechea-Encabo A *et al* 2012 *J. Cryst. Growth*. **353** 1–4
- [25] Albert S, Bengoechea-Encabo A, Lefebvre P, Sanchez-Garcia M A, Calleja E, Jahn U and Trampert A 2011 *Appl. Phys. Lett.* **99** 131108
- [26] Furtmayr F, Vilemeyer M, Stutzmann M, Arbiol J, Estradé S, Peiró F, Morante J R and Eickhoff M 2008 *J. Appl. Phys.* **104** 034309
- [27] Wu J and Walukiewicz W 2003 *Superlattices & Microstructures* **34** 63
- [28] Ishikawa R, Okunishi E, Sawada H, Kondo Y, Hosokawa F and Abe E 2011 *Nat. Materials* **10** 278–81
- [29] Nguyen H P T, Zhang S, Connie A T, Kibria M G, Wang Q, Shih I and Mi Z 2013 *Nano Lett.* **13** 5437
- [30] Mukai T, Yamada M and Nakamura S 1999 *Jpn. J. Appl. Phys.* **38** 3976
- [31] Enya Y *et al* 2009 *Appl. Phys. Express* **2** 082101
- [32] Kong X, Albert S, Bengoechea-Encabo A, Sanchez-Garcia M A, Calleja E and Trampert A 2012 *Nanotechnology* **23** 485701
- [33] Albert S, Bengoechea-Encabo A, Sanchez-Garcia M A, Calleja E and Jahn U 2013 *J. Appl. Phys.* **113** 114306
- [34] Wang T, Nakagawa D, Wang J, Sugahara T and Sakai S 1998 *Appl. Phys. Lett.* **73** 3571
- [35] Park I-K, Kwon M-K, Cho C-Y, Kim J-Y, Cho C-H and Park S-J 2008 *Appl. Phys. Lett.* **92** 253105
- [36] Li S X, Yu K M, Wu J, Jones R E, Walukiewicz W, Ager J W III, Shan W, Haller E E, Lu H and Schaff W J 2005 *Phys. Rev. B* **71** 161201
- [37] Tourbot G, Bougerol C, Grenier A, Den Hertog M, Sam-Giao D, Cooper D, Gilet P, Gayral B and Daudin B 2011 *Nanotechnology* **22** 075601